

## SERIAL ATA PLUG FOR 1.8" HDD PLUG

### 1.0 SCOPE

This Product Specification covers the performance requirements of the Serial ATA / High Speed Serialized device plug connector.

### 2.0 PRODUCT DESCRIPTION

### 2.1 PRODUCT NAME AND SERIES NUMBER(S)

#### Product Name

### Part Number

SERIAL ATA PLUG, RIGHT ANGLE SURFACE MOUNT, 1.8" HDD

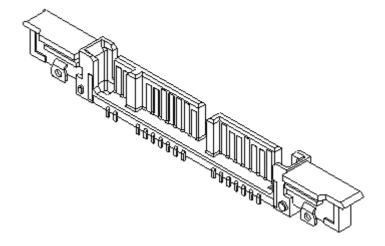
78103-0001

#### 2.2 DIMENSIONS, MATERIALS, PLATINGS AND MARKINGS

See Sales Drawing SD-78103-101 for information on dimensions, materials, platings and markings.

### 2.3 SAFETY AGENCY APPROVALS

UL FILE	:	TBD
CSA	:	TBD



### TENTATIVE RELEASE :

THIS SPECIFICATION IS BASED ON DESIGN OBJECTIVES AND IS STRICTLY TENTATIVE. PRELIMINARY TEST DATA MAY EXIST, BUT THIS SPECIFICATION IS SUBJECTED TO CHANGE BASED ON THE RESULTS OF ADDITIONAL TESTING AND EVALUATION.

	REVISION:	ECR/ECN INFORMATION:	TITLE: SEF	RIAL ATA PLUG		SHEET No.
	2	EC No: <b>S2008-0484</b>	RIGHT ANO	RIGHT ANGLE, SURFACE MOUNT 1.8" HDD		
		<u>DATE:</u> 2007/11/29				
	DOCUMENT NUMBER:		CREATED / REVISED BY:	CHECKED BY:	APPRO	<u>OVED BY:</u>
		YKOH 2007/12/12	KCLING	2007/12/12		
				TEMPLATE FILENAM	E: PRODUCT_SPE	C[SIZE_A4](V.1).DOC



### 3.0 APPLICABLE DOCUMENTS AND SPECIFICATIONS

The following documents form a part of this specification to the extend specified herewith. In the event of conflict between the requirements of this specification and the product drawing, the product drawing shall take precedence. In addition, in event of conflict between the requirements of this specification and the referenced documents, this specification shall take precedence.

Serial ATA Workgroup Specification

### 4.0 RATINGS

#### 4.1 VOLTAGE 30 Volts Max.

### **4.2 CURRENT** 1.5 Amps DC or AC (RMS). Max. @ 60 Hz

### **4.3 TEMPERATURE** Operating : - 40°C to + 105°C Non-Operating : - 40°C to + 105°C

## **4.4 HUMIDITY** 20% - 80%

20% - 00%

### 4.5 PRESSURE

650 mm – 800 mm Hg

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-	DATE: 2007/11/29		1.8" HDD		
DOCUMEN	T NUMBER:	CREATED / REVISED BY:	CHECKED BY:	APPRO	OVED BY:
PS	S-78103-002	GMENARLY 2007/11/29	YKOH 2007/12/12	KCLING	2007/12/12
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#### 5.0 PERFORMANCE

## 5.1 ELECTRICAL REQUIREMENTS

ITEM	DESCRIPTION	TEST CONDITION	REQUIREMENT	
1	Low Level Contact Resistance (LLCR)	Subject mated contacts assembled in housing to <b>20</b> mV maximum open circuit at <b>100</b> mA maximum. (EIA 364-23)	<b>30</b> mΩ MAXIMUM [initial] Resistance increase <b>15</b> mΩ MAXIMUM [after stress]	
2	Insulation Resistance	After <b>500</b> VDC for <b>1</b> minute, measure the insulation resistance between adjacent terminals of the mated and unmated connector assemblies. (EIA 364-21)	<b>1000</b> Megohms MINIMUM	
3	Dielectric Withstanding Voltage	Subject a voltage of <b>500</b> VAC for <b>1</b> minute between adjacent terminals of mated and unmated connector at sea level. (EIA 364-20 Method B)	No breakdown	

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L	<u>DATE:</u> 2007/11/29		1.8" HDD		
DOCUMEN	T NUMBER:	CREATED / REVISED BY:	CHECKED BY:	APPRO	<u>OVED BY:</u>
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	4	Connector Insertion and Removal Forces (SATA Backplane and Cables)	Mate and Unmate connector assemblies at a rate of <b>12.5</b> mm per minute. (EIA 364-13)	(1) Backp (2)Cable (Power (1) Backp (af (2)Cable (1) (a (1) th (3)Cable (1)	UM insertio plane Recep 20N Receptacle: r or Signal) 45N And UM remova plane Recep 2.5N ter 500 cycle 10N fter 50 cycle 10N mough 5 cycle Signal Rece Non-Latching 10N fter 50 cycle	tacle: I force tacle: es) eptacle: g) eptacle: g)
	5	Durability	<b>50</b> cycles for internal cabled application, <b>500</b> cycles for backplane/blindmate application. All at a maximum rate of <b>200</b> cycles per hour. (EIA 364-09)	Meet additiona the t	Physical dam t requiremen l tests as sp test sequence Section 7.0	nts of ecified in ce in
	6	Resistance to Soldering Heat	Refer to Section 10.0 for soldering profile.	No dama	age in appea connector	arance of
	7	Terminal Retention Force	Apply axial pull out force on terminal in the housing at a rate of <b>25.4</b> mm per minute.	MINIM	<b>4.45 N</b> UM retentio	n force
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2		EC No: <b>S2008-0484</b>	RIGHT ANGLE, SURF		OUNT	<b>4</b> of <b>10</b>
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	8	Physical Shock	Subject mated connector to <b>30</b> g's half-sine shock pulses of <b>11</b> msec duration. Three shocks in each direction applied along three mutually perpendicular planes for a total of <b>18</b> shocks. (EIA 364-27 Condition H)	No Physical damage No discontinuities of <b>1</b> μs or longer duration Test Set-Up in Section 8.0	
-	9 Random Vibration		Subject mated connector to <b>5.35</b> g's RMS. <b>30</b> minutes in each of the three mutually perpendicular planes. (EIA 364-28 Condition V Test letter A)	No discontinuities of <b>1</b> μs or longer duration Test Set-Up in Section 8.0	
-	10	Solderability	Solder Time: $3 \pm 0.5$ seconds Solder Temperature: $260 \pm 5$ °C (MIL-STD-202, Method 208)	Dipped portion should have <b>95</b> % continuous new solder coating coverage	

## 5.3 ENVIRONMENTAL REQUIREMENTS

ITEM	DESCRIPTION	TEST CONDITION	REQUIREMENT
11	Temperature Life	Subject mated connector to temperature life at + <b>85</b> °C for <b>500</b> hours. (EIA 364-17 Test Condition III Method A)	No Physical damage Meet requirements of additional tests as specified in the test sequence in Section 7.0
12	Thermal Shock	Subject connector to <b>10</b> cycles between - <b>55</b> °C and + <b>85</b> °C. (EIA 364-32 Test Condition I)	No Physical damage Meet requirements of additional tests as specified in the test sequence in Section 7.0

REVISION: 2	ECR/ECN INFORMATION: EC No: <b>\$2008-0484</b> DATE: <b>2007/11/29</b>		RIAL ATA PLUG BLE, SURFACE M 1.8" HDD	OUNT	<u>SHEET No.</u> 5 of 10
DOCUMEN	T NUMBER:	CREATED / REVISED BY:	CHECKED BY:	APPRO	OVED BY:
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1	3	Humidity	Subject the connector to temperature and humidity of <b>40</b> °C with <b>90</b> % to <b>95</b> % RH for <b>96</b> hours. (EIA 364-31 Method II Test Condition A)	
1	4	Mixed Flowing Gas	Half of the samples are exposed unmated for 7 days, then mated for the remaining 7 days. The other half of the samples mated for full 14 days test period. (EIA 364-65, Class 2A)	Meet requirements of

## 6.0 PACKAGING

Refer to Sales Drawing SD-78103-101 for packaging details.

REVISION:	ECR/ECN INFORMATION:	TITLE: SEF	RIAL ATA PLUG		SHEET No.
2	EC No: <b>\$2008-0484</b>	KIGHT ANGEL, SUKTACE MOUNT 60	<b>6</b> of <b>10</b>		
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## 7.0 TEST SEQUENCES

Test Group ∨	Α	В	С	D	Е	F	G	Н
Test or Examination ⇐								
Examination of the connector(s)	1, 5	1, 9	1, 8	1, 8	1, 7	1	1, 5	
Low Level Contact Resistance (LLCR)	2, 4	3, 7	2, 4, 6		4, 6			
Insulation Resistance				2, 6				
Dielectric Withstanding Voltage				3, 7				
Current Rating			7					
Insertion Force		2					2	
Removal Force		8					4	
Durability	3	4(a)			2(a)		3	
Physical Shock		6						
Vibration		5						
Humidity				5				
Temperature Life			3					
Reseating (manually unplug/plug three times)			5		5			
Thermal Shock				4				
Terminal Retention Force						2, 4		
Resistance to Soldering Heat						3		
Solderability								1
Mixed Flowing Gas					3			

Note:-

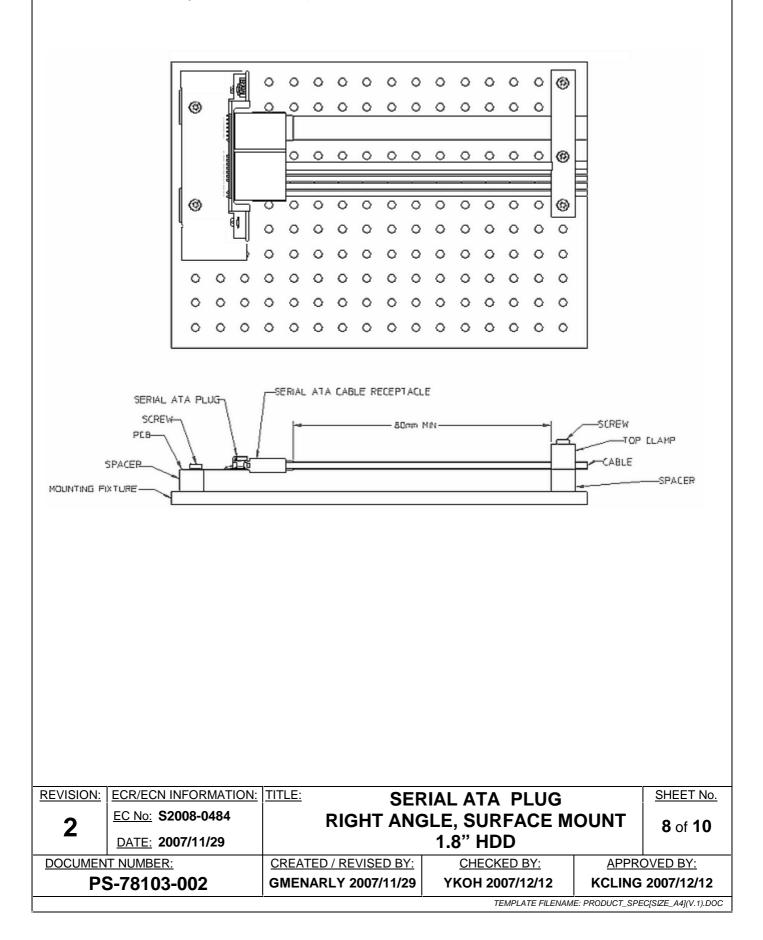
(a) Preconditioning, 20 cycles for the 50-durability cycle requirement, 50 cycles for the 500durability cycles requirement. The insertion and removal cycle is at the maximum rate of 200 cycles per hour.

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## 8.0 VIBRATION/SHOCK TEST SET-UP (REFERENCE ONLY)

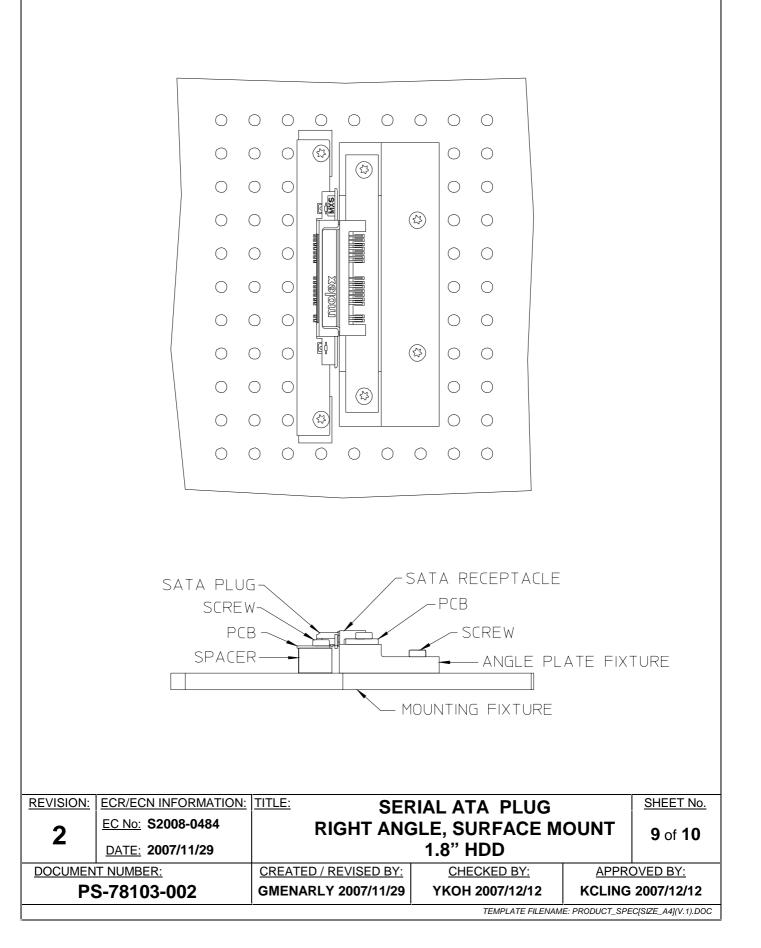
Serial ATA Plug with Cable Receptacle





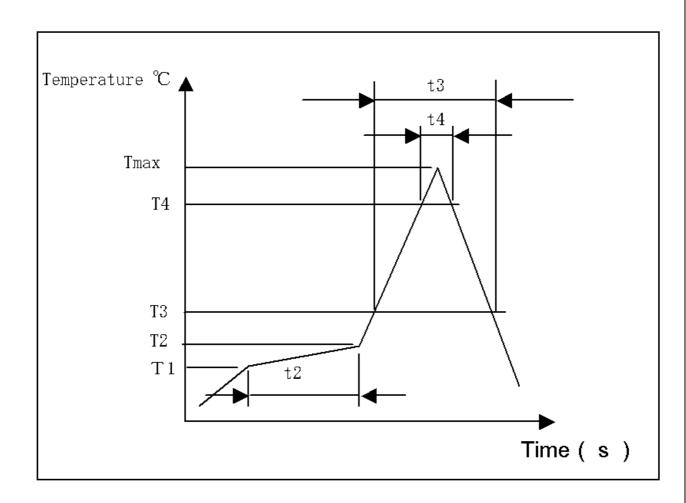
## 9.0 VIBRATION/SHOCK TEST SET-UP (REFERENCE ONLY)

Serial ATA Plug with Blind-mate Receptacle





## 10.0 SOLDERING PROFILE



Description	Requirement
Tmax	260°C
T4, t4	255°C, 10 second max.
T3, t3	220°C, 80 second max.
T1 & T2, t2	$170 \pm 10^{\circ}$ C, 160 second max.
Number of reflow passes	2

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